ON Semiconductor

Is Now



To learn more about onsemi™, please visit our website at www.onsemi.com

onsemi and ONSEMI. and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. onsemi reserves the right to make changes at any time to any products or information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/ or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use onsemi products for any such unintended or unauthorized application,

6-Channel Differential 1:2 Switch for PCle 3.0 and DisplayPort 1.2

The NCN3612B is a 6–Channel differential SPDT switch designed to route PCI Express Gen3 and/or DisplayPort 1.2 signals. Due to the ultra–low ON–state capacitance (2.1 pF typ) and resistance (8 Ω typ), this switch is ideal for switching high frequency signals up to a signal bit rate (BR) of 8 Gbps. This switch pinout is designed to be used in BTX form factor desktop PCs and is available in a space–saving $5\mathrm{x}11\mathrm{x}0.75$ mm WQFN56 package. The NCN3612B uses 80% less quiescent power than other comparable PCIe switches.

Features

- BTX Pinout
- V_{DD} Power Supply from 3 V to 3.6 V
- Low Supply Current: 250 μA typ
- 6 Differential Channels, 2:1 MUX/DEMUX
- Compatible with Display Port 1.2 & PCIe 3.0
- Data Rate: Supports 8 Gbps
- Low R_{ON} Resistance: 8 Ω typ
- Low Con Capacitance: 2.1 pF
- Space Saving, Small WQFN-56 Package
- This is a Pb-Free Device

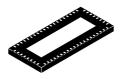
Typical Applications

- Notebook Computers
- Desktop Computers
- Server/Storage Networks



ON Semiconductor®

http://onsemi.com



MARKING DIAGRAM

NCN3612B AWLYYWWG

WQFN56 CASE 510AK

1

A = Assembly Location

WL = Wafer Lot
 YY = Year
 WW = Work Week
 G = Pb-Free Package

ORDERING INFORMATION

Device	Package	Shipping [†]
NCN3612BMTTWG	WQFN56 (Pb-Free)	2000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

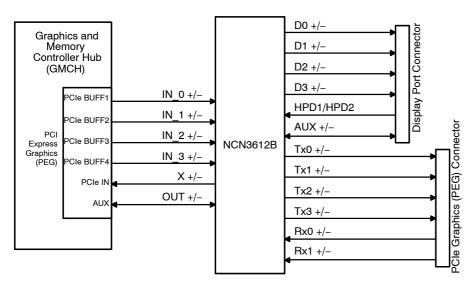


Figure 1. Application Schematic

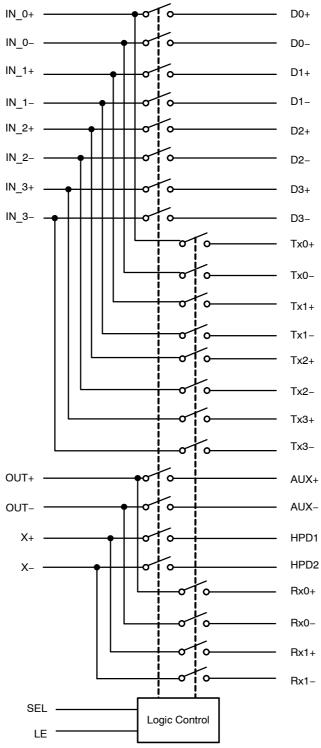


Figure 2. NCN3612B Block Diagram

TRUTH TABLE (SEL Control)

Function	SEL
PCI Express Gen3 Path is Active (Tx, Rx)	L
Digital Video Port is Active (D, HPD, AUX)	Н

TRUTH TABLE (Latch Control)

LE	Internal Mux Select	
L	Respond to Changes on SEL	
Н	Latched	

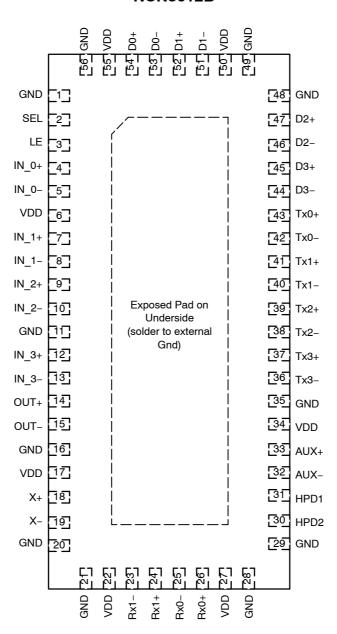


Figure 3. Pinout (Top View)

PIN FUNCTION AND DESCRIPTION

Pin	Name	Description
6, 17, 22, 27, 34,50, 55	VDD	DC Supply, 3.3 V ±10%
1, 11, 16, 20, 21, 28, 29, 35, 48, 49, 56	GND	Power Ground.
Exposed Pad	-	The exposed pad on the backside of package is internally connected to Gnd. Externally the exposed pad should also be user-connected to GND.
2	SEL	SEL controls the mux through a flow–through latch. Do not float this pin. SEL = 0 for PCIE Mode; SEL = 1 for DP Mode
3	LE	LE controls the latch gate. Do not float this pin.
4	IN_0+	Differential input from GMCH PCIE outputs. IN_0+ makes a differential pair with IN_0
5	IN_0-	Differential input from GMCH PCIE outputs. IN_0- makes a differential pair with IN_0+.
7	IN_1+	Differential input from GMCH PCIE outputs. IN_1+ makes a differential pair with IN_1
8	IN_1-	Differential input from GMCH PCIE outputs. IN_1- makes a differential pair with IN_1+.
9	IN_2+	Differential input from GMCH PCIE outputs. IN_2+ makes a differential pair with IN_2
10	IN_2-	Differential input from GMCH PCIE outputs. IN_2- makes a differential pair with IN_2+.
12	IN_3+	Differential input from GMCH PCIE outputs. IN_3+ makes a differential pair with IN_3
13	IN_3-	Differential input from GMCH PCIE outputs. IN_3- makes a differential pair with IN_3+.
14	OUT+	Pass-through output from AUX+ input when SEL = 1. Pass-through output from Rx0+ input when SEL = 0.
15	OUT-	Pass-through output from AUX- input when SEL = 1. Pass-through output from Rx0- input when SEL = 0.
18	X+	X+ is an analog pass-through output corresponding to Rx1+.
19	X-	X- is an analog pass-through output corresponding to the Rx1- input. The path from Rx1- to X- must be matched with the path from Rx1+ to X+. X+ and X- form a differential pair when the pass-through mux mode is selected.
23	Rx1-	Differential input from PCIE connector or device. Rx1– makes a differential pair with Rx1+. Rx1– is passed through to the X– pin on the path that matches the Rx1+ to X+ pin.
24	Rx1+	Differential input from PCIE connector or device. Rx1+ makes a differential pair with Rx1 Rx1+ is passed through to the X+ pin when SEL = 0.
25	Rx0-	Differential input from PCIE connector or device. Rx0- makes a differential pair with Rx0+. Rx0- is passed through to the OUT- pin when SEL = 0.
26	Rx0+	Differential input from PCIE connector or device. Rx0+ makes a differential pair with Rx0 Rx0+ is passed through to the OUT+ pin when SEL = 0.
30	HPD2	Negative low frequency HPD input handshake protocol signal (normally not connected).
31	HPD1	Positive low frequency HPD input handshake protocol signal.
32	AUX-	Differential input from HDMI/DP connector. AUX- makes a differential pair with AUX+. AUX- is passed through to the OUT- pin when SEL = 1.
33	AUX+	Differential input from HDMI/DP connector. AUX+ makes a differential pair with AUX AUX+ is passed through to the OUT+ pin when SEL = 1.
37, 36	Tx3+, Tx3-	Analog pass-through output#2 corresponding to IN_3+ and IN_3- when SEL = 0.
39, 38	Tx2+, Tx2-	Analog pass-through output#2 corresponding to IN_2+ and IN_2- when SEL = 0.
41, 40	Tx1+, Tx1-	Analog pass-through output#2 corresponding to IN_1+ and IN_1- when SEL = 0.
43, 42	Tx0+, Tx0-	Analog pass-through output#2 corresponding to IN_0+ and IN_0- when SEL = 0.
45, 44	D3+, D3-	Analog pass–through output#1 corresponding to IN_3+ and IN_3-, when SEL = 1.
47, 46	D2+, D2-	Analog pass-through output#1 corresponding to IN_2+ and IN_2-, when SEL = 1.
52, 51	D1+, D1-	Analog pass–through output#1 corresponding to IN_1+ and IN_1-, when SEL = 1.
54, 53	D0+, D0-	Analog pass-through output#1 corresponding to IN_0+ and IN_0-, when SEL = 1.

MAXIMUM RATINGS

Parameter	Symbol	Rating	Unit
Power Supply Voltage	V_{DD}	-0.5 to 5.3	V_{DC}
Input/Output Voltage Range of the Switch (Tx, Rx, D, HPD, AUX, IN_, OUT, X)	V _{IS}	-0.5 to V _{DD} + 0.3	V _{DC}
Selection Pin Voltages (SEL and LE)	V _{IN}	-0.5 to V _{DD} + 0.3	V_{DC}
Continuous Current Through One Switch Channel	I _{IS}	±120	mA
Maximum Junction Temperature (Note 1)	T _J	150	°C
Operating Ambient Temperature	T _A	-40 to +85	°C
Storage Temperature Range	T _{stg}	-65 to +150	°C
Thermal Resistance, Junction-to-Air (Note 2)	$R_{ hetaJA}$	37	°C/W
Latch-up Current (Note 3)	I _{LU}	±100	mA
Human Body Model (HBM) ESD Rating (Note 4)	ESD HBM	7000	V
Machine Model (MM) ESD Rating (Note 4)	ESD MM	400	V
Moisture Sensitivity (Note 5)	MSL	Level 1	-

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

- Power dissipation must be considered to ensure maximum junction temperature (T_J) is not exceeded.
 This parameter is based on EIA/JEDEC 51-7 with a 4-layer PCB, 80 mm x 80 mm, two 1oz Cu material internal planes and top planes of
- Latch up Current Maximum Rating: ±100 mA per JEDEC standard: JESD78.
 This device series contains ESD protection and passes the following tests: Human Body Model (HBM) ±7.0 kV per JEDEC standard: JESD22–A114 for all pins.

 Machine Model (MM) ±400 V per JEDEC standard: JESD22–A115 for all pins.

 5. Moisture Sensitivity Level (MSL): 1 per IPC/JEDEC standard: J–STD–020A.

ELECTRICAL CHARACTERISTICS (V_{DD} = +3.3V ±10%, T_A = -40°C to +85°C, unless otherwise noted. All Typical values are at V_{DD} = +3.3 V, T_A = +25°C, unless otherwise noted.)

Symbol	Characteristics	Conditions	Min	Тур	Max	Unit
POWER S	UPPLY					
V _{DD}	Supply Voltage Range		3.0	3.3	3.6	V
I_{DD}	Power Supply Current	V_{DD} = 3.6 V, V_{IN} = GND or V_{DD}		250	350	μΑ
DATA SW	ITCH PERFORMANCE (for both PC	Cle and DisplayPort applications, unless otherwise	noted)	•		
V _{IS}	Data Input/Output Voltage Range		0		1.2	V
R _{ON}	On Resistance (Tx, Rx)	$V_{DD} = 3 \text{ V}, V_{IS} = 0 \text{ V to } 1.2 \text{ V}, I_{IS} = 15 \text{ mA}$		8.0	13	Ω
R _{ON}	On Resistance (D, HPD, AUX)	$V_{DD} = 3 \text{ V}, V_{IS} = 0 \text{ V to } 1.2 \text{ V}, I_{IS} = 15 \text{ mA}$		9.0	13	Ω
R _{ON(flat)}	On Resistance Flatness	$V_{DD} = 3 \text{ V}, V_{IS} = 0 \text{ V to } 1.2 \text{ V}, I_{IS} = 15 \text{ mA}$ (Note 6)		0.1	1.24	Ω
ΔR_{ON}	On Resistance Matching (Tx, Rx)	$V_{DD} = 3 \text{ V}, V_{IS} = 0 \text{ V}, I_{IS} = 15 \text{ mA}$		0.35		Ω
ΔR_{ON}	On Resistance Matching (D, HPD, AUX)	$V_{DD} = 3 \text{ V}, V_{IS} = 0 \text{ V}, I_{IS} = 15 \text{ mA}$		0.35		Ω
C _{ON}	On Capacitance	f = 1 MHz, Switch On, Open Output		2.1		pF
C _{OFF}	Off Capacitance	f = 1 MHz, Switch Off		1.6		pF
I _{ON}	On Leakage Current (IN_/ X/OUT)	V _{DD} = 3.6 V, V _{IN} = Vx = V _{OUT} = 0 V, 1.2 V; Switch On to D/HPD/AUX or Tx/Rx; outputs unconnected	-1		+1	μΑ
I _{OFF}	Off Leakage Current (D/Tx/HPD/Rx/AUX)	$V_{DD} = 3.6 \text{ V}, V_{IN} = V_{X} = V_{OUT} = 0 \text{ V}, 1.2 \text{ V};$ Switch Off; $V_{D} = V_{HPD} = V_{AUX} \text{ or } V_{D} = V_{HPD} = V_{AUX} \text{ set to } 1.2 \text{ V}, 0 \text{ V}$	-1		+1	μΑ
CONTROL	LOGIC CHARACTERISTICS (SE	L and LE pins)				
V_{IL}	Off voltage input		0		8.0	V
V_{IH}	High voltage input		2		V_{DD}	V
I _{IN}	Off voltage input	V _{IN} = 0 V or V _{DD}	-1		+1	μΑ
C _{IN}	High voltage input	f = 1 MHz		1		pF
DYNAMIC	CHARACTERISTICS					
BR	Signal Data Rate			8		Gbps
D _{IL}	Differential Insertion Loss	f = 100 MHz		-0.7		dB
		f = 2.7 GHz		-1.3		
		f = 4 GHz		-2		
D _{ISO}	Differential Off Isolation	f = 100 MHz		-54		dB
		f = 2.7 GHz		-23		
		f = 4 GHz		-18		
D _{CTK}	Differential Crosstalk	f = 100 MHz		-50		dB
		f = 2.7 GHz		-32		
		f = 4 GHz		-30		
D _{RL}	Differential Return Loss	f = 100 MHz		-20		dB
		f = 3.7 GHz		-10		1
	1	f = 4 GHz		-5		1

^{6.} Guaranteed by characterization and/or design.

SWITCHING CHARACTERISTICS (V_{DD} = +3.3 V, T_A = 25°C, unless otherwise specified)

Symbol	Characteristics	Conditions	Min	Тур	Max	Unit
t _{b-b}	Bit-to-bit skew	Within the same differential pair		7		ps
t _{ch-ch}	Channel-to-channel skew	Maximum skew between all channels		55		ps

SELECTION PINS SWITCHING CHARACTERISTICS (V_{DD} = +3.3 V, T_A = 25°C, unless otherwise specified)

Symbol	Characteristics	Conditions	Min	Тур	Max	Unit
T _{SELON}	SEL to Switch turn ON time	V_{IS} = 1 V, R_L = 50 Ω , V_{LE} = V_{DD} , C_L = 100 pF		9.5		ns
T _{SELOFF}	SEL to Switch turn OFF time	V_{IS} = 1 V, R_L = 50 Ω , V_{LE} = V_{DD} , C_L = 100pF		5		ns
T _{SET}	LE setup time SEL to LE	V_{IS} = 1 V, R_L = 50 Ω , V_{LE} = V_{DD} , C_L = 100 pF		1		ns
T _{HOLD}	LE hold time LE to SEL	V_{IS} = 1 V, R_L = 50 Ω , V_{LE} = V_{DD} , C_L = 100 pF		1		ns

TYPICAL OPERATING CHARACTERISTICS

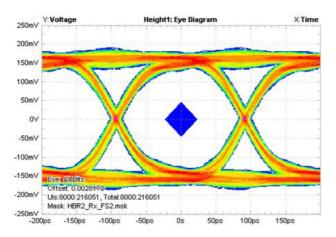


Figure 4. Reference DisplayPort 1.2 Eye Diagram without Switch at 5.4 Gbps, 340 mV_{pp} Differential Swing

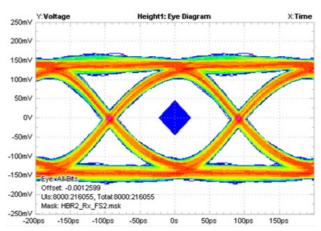


Figure 5. DisplayPort 1.2 Eye Diagram through NCN3612B at 5.4 Gbps, 340 mV_{pp} Differential Swing

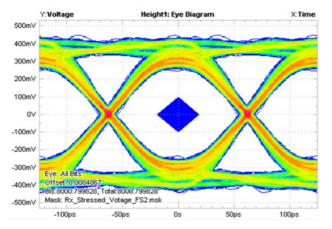


Figure 6. Reference PCle 3.0 Eye Diagram without Switch at 8 Gbps, 800 mV_{pp} Differential Swing

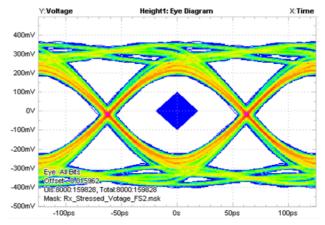


Figure 7. PCIe 3.0 Eye Diagram through NCN3612B at 8 Gbps, 800 mV $_{\rm pp}$ Differential Swing

TYPICAL OPERATING CHARACTERISTICS

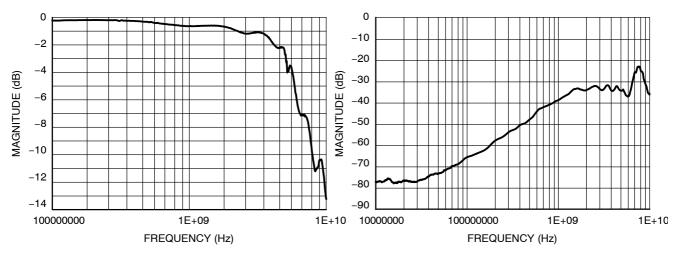


Figure 8. Differential Insertion Loss

Figure 9. Differential Crosstalk

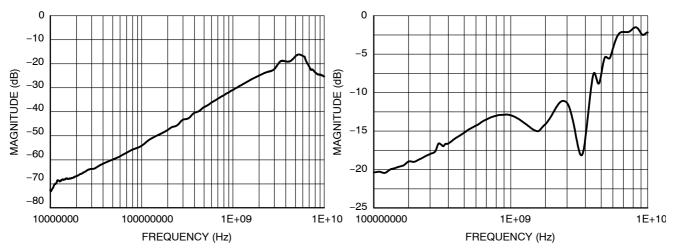


Figure 10. Differential Off Isolation

Figure 11. Differential Return Loss

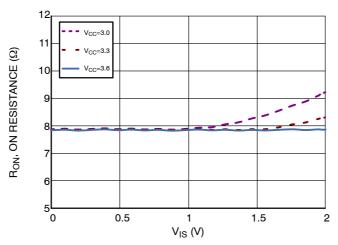


Figure 12. R_{ON} vs. V_{IS}

PARAMETER MEASUREMENT INFORMATION

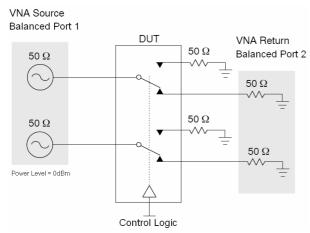
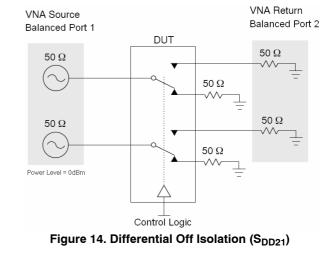


Figure 13. Differential Insertion Loss (S_{DD21}) and Differential Return Loss (S_{DD11})



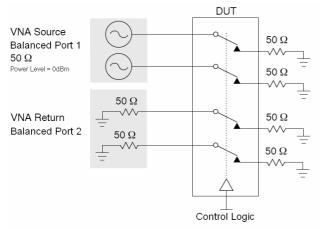


Figure 15. Differential Crosstalk (S_{DD21})

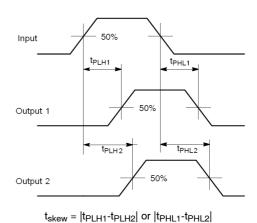
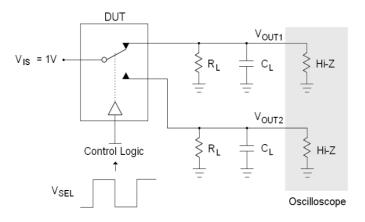


Figure 16. Bit-to-Bit and Channel-to-Channel Skew



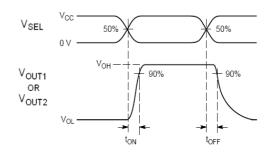


Figure 17. toN and toFF

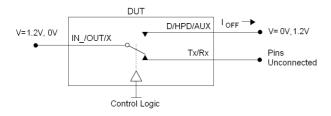


Figure 18. Off State Leakage

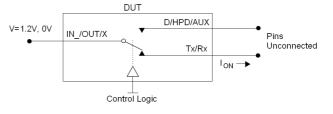
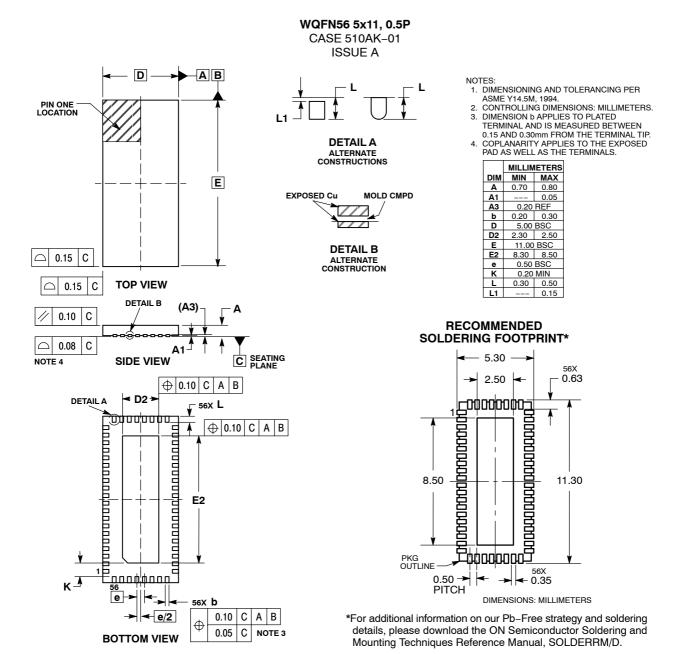


Figure 19. On State Leakage

PACKAGE DIMENSIONS



ON Semiconductor and are registered trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor P.O. Box 5163, Denver, Colorado 80217 USA

Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com

N. American Technical Support: 800-282-9855 Toll Free USA/Canada

Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910 Japan Customer Focus Center

Phone: 81-3-5773-3850

ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative